Digital Bat Ears

ECE 445 Design Review

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Group #32

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1.0 Introduction

1.1 Statement of Purpose:

The goal of this project is to develop a full spectrum bat detector at a reasonable cost. This device will record bat calls up to 100 KHz, downshift the calls into the human hearing range (20 Hz-20 KHz), and play the calls back through an audio jack without seriously distorting the signal. Also, the device will store the processed/original data for further processing on an SD card and provide an intuitive interface to the user. Bat detectors currently available on the market which have this functionality range from \$500-\$1000. We aim to provide similar functionality but only using \$50-\$100 worth of parts.

1.2 Objectives:

- 1.2.1 Goals:
 - 1. Characterize a variety of MEMS microphones to determine their sensitivity in the ultrasonic range.
 - 2. Based on the information from (1), design an amplifier/filter stage based on the empirical frequency response of said microphones.
 - 3. Develop algorithms to compress/downshift ultrasonic data into the human hearing range and implement on a microcontroller.
 - 4. Develop UI to interact with microcontroller.
 - 5. Develop algorithms to store data from microcontroller to SD card

1.2.2 Functions:

- 1. Records audio in the ultrasonic range (up to 100 KHz)
- 2. Downshifts audio and plays it back through the headphone jack.
- 3. Saves raw and/or downshifted data to the SD card
- 4. Provides user interface to repeat or delete different recordings

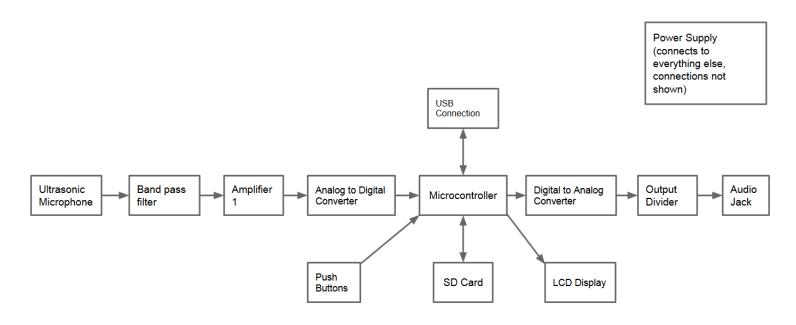
1.2.3 Features:

- 1. Contains a MEMS ultrasonic microphone for low cost, high accuracy recording
- 2. Contains a low power TI microcontroller for fast and efficient processing
- 3. Powered by standard AA batteries
- 4. Interfaces with standard 3.5 mm headphones and SD cards

- 5. Electronics are stored in a durable case
- 1.2.4 Benefits:
 - 1. Provides advanced functionality at a low cost
 - 2. Has a friendly and intuitive UI
 - 3. Provides output in a format which can be easily analyzed on a PC
 - 4. Durable and portable

2.0 Design

2.1 Block Diagram:



2.2 Block Descriptions:

Ultrasonic Microphone

Input	Output
Sound from outside environment,	AC voltage limited between 0 and 1 V
which will include ultrasonic bat calls.	(ideally) which represents the
	ultrasonic sound.

The device we have chosen for our ultrasonic microphone is the Knowles SPQ0410HR5H-B. This

is a MEMS microphone which has sensitivity in the ultrasonic range, which suits our purposes. One challenge that this device (as well as all available MEMS microphones) bring is that it has contacts only on the bottom of the package, as shown in Figure 2.1. A custom PCB must be created to specifically test and later use the device. In addition, a reflow oven (or similar process) must be used to solder the device according to the given soldering profile, as shown in Figure 2.2.

The microphone has a sensitivity of -42 dBV/Pa (measured at 1 kHz), which means that the voltage from the microphone actually decreases with increases in sound volume.

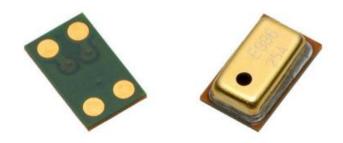
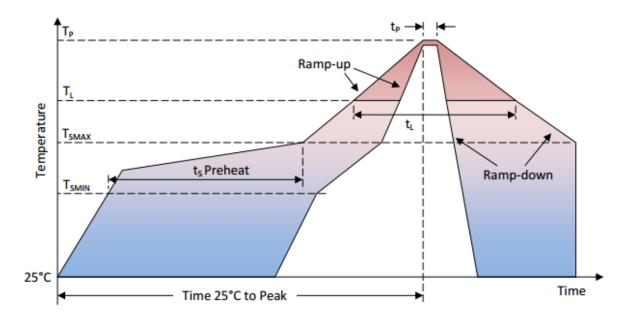
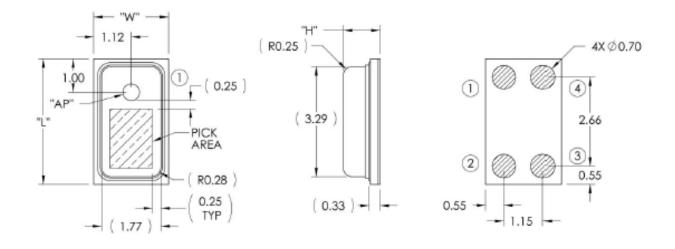


Figure 2.1 – Microphone packaging



Profile Feature	Pb-Free
Average Ramp-up rate (T _{SMAX} to T _P)	3°C/second max.
Preheat	
 Temperature Min (T_{SMIN}) 	150°C
 Temperature Max (T_{SMAX}) 	200°C
 Time (T_{SMIN} to T_{SMAX}) (t_s) 	60-180 seconds
Time maintained above:	
 Temperature (T_L) 	217°C
 Time (t_L) 	60-150 seconds
Peak Temperature (T _P)	260°C
Time within 5° C of actual Peak Temperature (t _P)	20-40 seconds
Ramp-down rate (T _P to T _{SMAX})	6°C/second max
Time 25°C to Peak Temperature	8 minutes max

Figure 2.2 – Reflow Profile



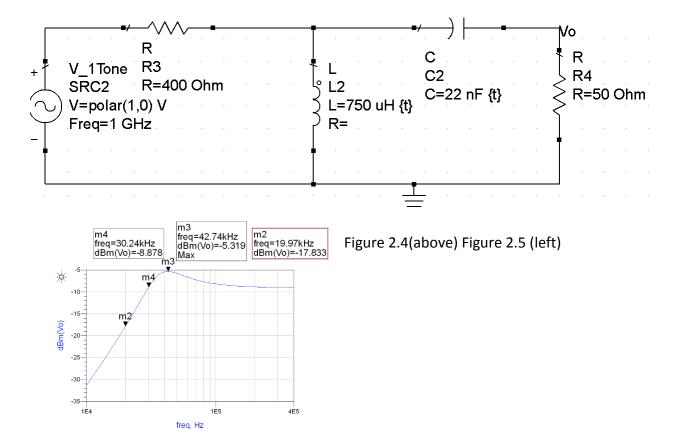
Item	Dimension	Tolerance
Length (L)	3.76	±0.10
Width (W)	2.24	±0.10
Height (H)	1.10	±0.10
Acoustic Port (AP)	Ø0.50	±0.05

Pin #	Pin Name	Туре	Description
1	V _{DD}	Power	Power Supply
2	GROUND	Power	Ground
3	GROUND	Power	Ground
4	OUTPUT	Signal	Output Signal

Band Pass Filter

Inputs	Outputs	
Raw analog data from microphone.	Isolated ultrasonic calls	

In order to hear the ultra-sonic frequencies, we implemented a band pass filter to dampen the undesired frequencies. We ultimately decided to a single staged, passive filter. The Butterworth filter had too much gain in cutoff frequencies, and Chebychev filter did not enough total loss to satisfy the needs of the filter. Since our big concern is the lower frequencies, the inductor was used a shunted the high impedance. The rest of the circuit was model as a 50 ohm resistor. From the data sheet of the microphone, the source impedance was read to be 400 ohms. Using this data we set up our circuit simulations. Figure 2.4 shows the current layout chosen for the filter. After laying it out in ADS, Figure 2.5 shows the simulated frequency response.



Input Amplifier

Inputs	Outputs
Isolated ultrasonic bat calls (after filtering).	Voltage between 0 and 3.3 V, which is the full range of values for the A/D
	converter.

An amplifier used to amplify signals from the microphone to levels required for the analog to digital converter. The ADC has an input limit of 3.3V (for voltage values greater than or equal to 3.3V, ADC will convert it to the maximum value of 4095). Based on the 0-1 V range of the microphone and this requirement, we have designed a non-inverting op-amp circuit which will do the necessary amplification. The schematic for this device is given below in figure 2.6.

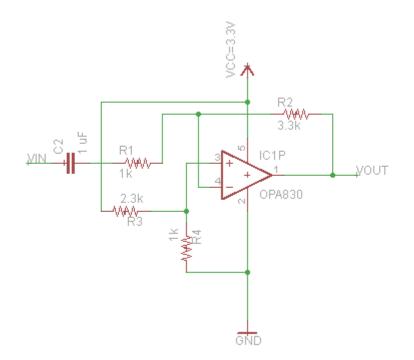


Figure 2.6 – Input Amplifier Schematic

This device has a gain given by the equation:

$$Vout = (1 - Vin)R2/R1$$

With R2 = 3.3k ohms and R1 = 1k ohm, the device obtains a gain of 3.3. With the input voltage limited between 0-1 V, our output is thus limited between 0-3.3 V. Also, the coupling capacitor was chosen based on the recommendation given in the SiSonic Design Guide (see references).

Analog to Digital Converter

Inputs	Outputs
Ultrasonic bat calls, filtered and	12 bit digital data representing the
amplified to the correct level.	bat calls, which will be sent to the microcontroller for processing.

The Analog to Digital Converter we've chosen is built-in to our microcontroller as a peripheral. It operates at 1 MSPS (one million samples per second or 1 MHz). With an upper limit of 100 KHz on our input signal, this allows us to oversample at 10x, which is ideal. This ADC has a resolution of 12 bits, which provides 2^{12} -1 = 4095 levels.

Microcontroller

Inputs	Outputs
 Digital bat call data from ADC User interface information	 Downshifted and compressed
from push buttons Stored data on SD card via	audio data will be sent to DAC Raw data to be saved on SD
serial connection Program information via USB	card, via serial connection UI information via serial
connection	connection to LCD

The microcontroller we've chosen is the Tiva TM4C123GH6PM. As the heart of the system, it is responsible for a great number of things, and connects to many different components. A pin diagram, as well as a pin table, given below in Figures 2.7 and 2.8, illustrate this.

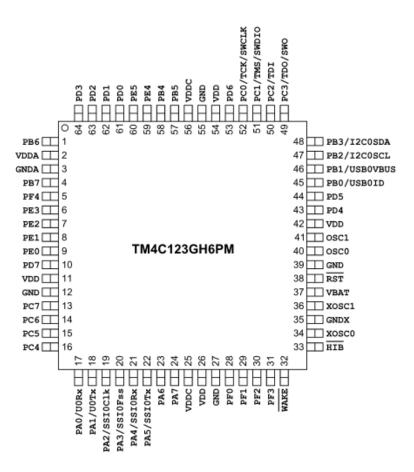


Figure 2.7 – Microcontroller Pin Diagram

Pin(s)	Description	Connections
2,11,26,42,54	Vdd/VddA pins	Connect to +3.3 V power
		supply
3,12,27,39,55	Ground pins	Connect to GND
17	GPIO/SPI	Use for SD card I/O
18	GPIO/SPI	Use for serial interface with
		LCD display
19-22,47-49	GPIO	Use with push buttons
6	ADC Input	Connect to output of
		amplifier/filter stage
52	GPIO	Send data serially to digital to
		analog converter
45-46	USB	Connect to USB plug
25,56	Vddc	Connect to +1.2 V power
		supply

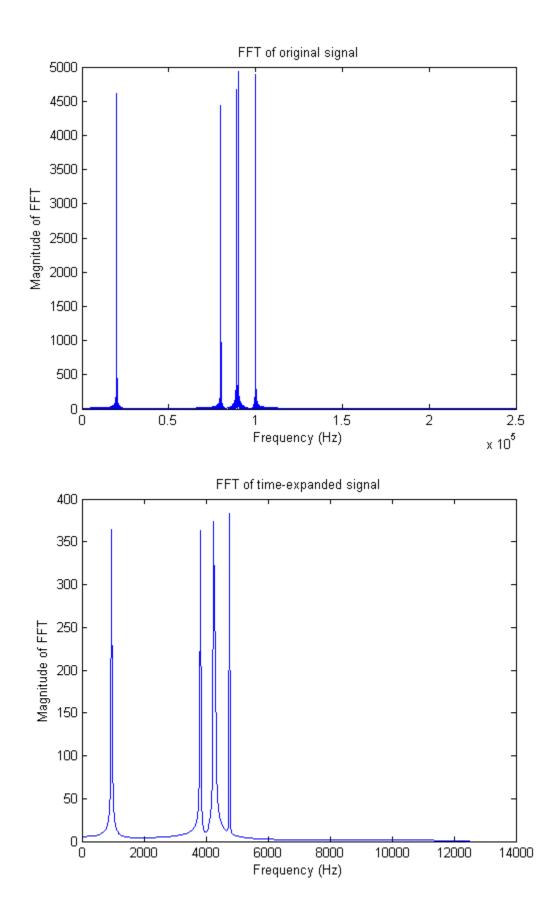
The microcontroller will be responsible for converting the bat calls in the 20 kHz to 100 kHz range into the human hearing range of 20 Hz to 20 kHz. A couple of algorithms and their MATLAB simulations are given below as two different ways to do this.

Frequency Shifting/Compression Algorithms

The first method is the time expansion method. It is precise, but is not an algorithm that can be done in real time. This is because the amount of memory used by the program will grow without bound.

```
%this code implements the time expansion method of compressing a frequency
%range. This is the ideal method since it is very precise. However this
%is not an algorithm intended for real time processing
Fs = 5e5; %sampling rate of 500 kHz
T = 1/Fs; %normal period calculation
L = 10000; %length of FFT
t = (0:L-1)*T; %time vector
% show initial signal's FFT
x1=0;
F = [1e5,2e4,8e4,8.9e4,9e4];
for i=F
   x1 = x1 + sin(2*pi*i*t);
end
%{
F = [1e5,8.1e4,8e4];
for i=F
   x1 = x1 + sin(2*pi*i*t);
end
%}
%{
F = [1e5];
for i=F
   x1 = x1 + sawtooth(i*t);
end
%}
lenFFT = 2^nextpow2(L);
figure(1);
```

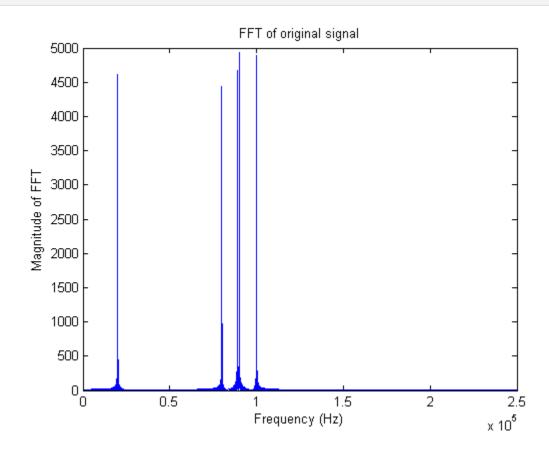
```
y = fft(x1,lenFFT);
f=Fs/2*linspace(0,1,lenFFT/2+1);
plot(f,abs(y(1:lenFFT/2+1)))
title('FFT of original signal')
xlabel('Frequency (Hz)')
ylabel('Magnitude of FFT')
%code to insert a zeros between each sample
x^2 = [];
a = 20;
for j=1:length(x1)
    x2 = [x2, x1(j), zeros(1,a)];
end
%need to low pass filter with cutoff frequency of w=pi/L
%create low pass filter using built in matlab functions
filter1 = fir1(100, 1/(a+1));
x2 = conv(x2, filter1);
%display final fft
figure(2);
y = fft(x2,lenFFT);
f=fix(Fs/(2*a))*linspace(0,1,fix(lenFFT/(2*a))+1);
plot(f,abs(y(1:fix(lenFFT/(2*a))+1)))
%f=Fs/2*linspace(0,1,lenFFT/2+1);
%plot(f,abs(y(1:lenFFT/2+1)))
title('FFT of time-expanded signal')
xlabel('Frequency (Hz)')
ylabel('Magnitude of FFT')
```

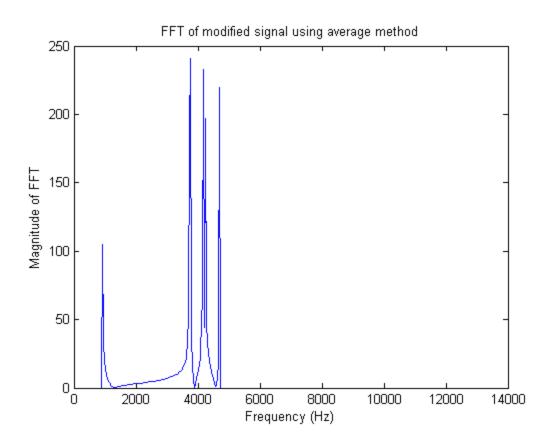


The second method is an averaging method. It does not give the ideal results but it can be done in real time.

```
%this code implements the approximation method. This
%method is not precise but can be done in real time
Fs = 5e5; %sampling rate of 500 kHz
T = 1/Fs; %normal period calculation
L = 10000; %length of FFT
t = (0:L-1)*T; %time vector
% show initial signal's FFT
x1 = 0;
F = [1e5,2e4,8e4,8.9e4,9e4];
for i=F
   x1 = x1 + sin(2*pi*i*t);
end
%{
F = [1e5,8.1e4,8e4];
for i=F
   x1 = x1 + sin(2*pi*i*t);
end
%}
%{
F = [1e5];
for i=F
   x1 = x1 + sawtooth(i*t);
end
%}
lenFFT = 2 \wedge nextpow2(L);
figure(3);
y1 = fft(x1,lenFFT);
f=Fs/2*linspace(0,1,lenFFT/2+1);
plot(f,abs(y1(1:lenFFT/2+1)))
title('FFT of original signal')
xlabel('Frequency (Hz)')
ylabel('Magnitude of FFT')
%build new frequency spectrum by averaging technique
```

```
a=20;
y2 = zeros(1, lenFFT/2+1);
for i = 1 : a : lenFFT/2+1
    j = i:i+a;
    if and((f(i) >= 2e4),(f(i) <= 1e5))</pre>
        y2(fix(i/(a+1))) = mean(y1(j));
    end
end
figure(4)
f=fix(Fs/(2*a))*linspace(0,1,fix(lenFFT/(2*a))+1);
plot(f,abs(y2(1:fix(lenFFT/(2*a))+1)))
%f=Fs/2*linspace(0,1,lenFFT/2+1);
%plot(f,abs(y(1:lenFFT/2+1)))
title('FFT of modified signal using average method')
xlabel('Frequency (Hz)')
ylabel('Magnitude of FFT')
```





User Interface

In addition to performing the previously mentioned signal processing, the microcontroller will also work with the LCD and push buttons to provide a user interface. A state diagram for this user interface is given below in Figure 2.9. See the LCD and push button sections for more information about these parts and how the contribute to the user interface.

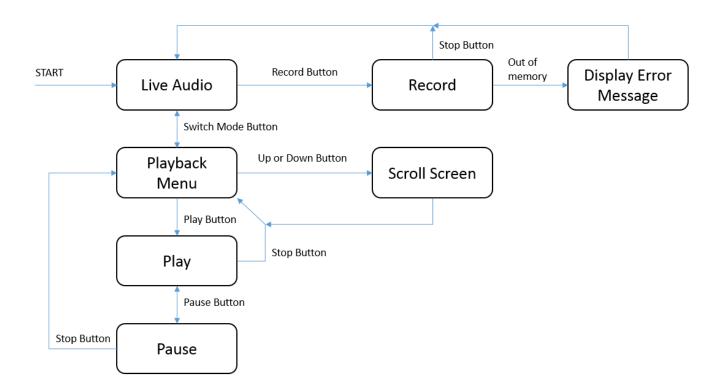


Figure 2.9 – User Interface state diagram

Digital to Analog Converter

Input	Output
Processed digital audio data from	Analog voltage to be send to output
microcontroller	amplifier. From 3.3V to 0V.

The digital to analog converter we've chosen to use is the Maxim Integrated MAX5216BGUA+. This device can operate at frequencies up to 50 MHz. Our output from the DAC is going to be limited to the human hearing range, with a maximum of 20 kHz. So this device greatly exceeds this basic requirement. The pin diagram for this device is given below in Figure 2.10.

TOP VIEW

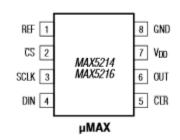


Figure 2.10 – Pin diagram for DAC

Output Divider

Input	Output	
Analog audio from DAC	Scaled audio to be sent directly to	
	headphones	

Given that the DAC will output a maximum of 3.3 V, a simple divider is needed to convert the voltage to a value which is acceptable for output to headphones.

The Ipod earbuds are the headphones we used for designing this stage. They have an input impedance of 23 ohms and a sensitivity of 109 dB SPL/mW. Additionally, the safe level for hearing ends at 85 dB SPL. Using this, we can calculate the power in mW that can be our maximum. 85 dB SPL/ 109 dB SPL/mW = 0.78 mW. Then, using the output impedance and the fact that P=I²R, we calculate the current going through the headphones as 0.18 mA. Now, with a voltage of 3.3 V from the DAC, we can calculate a series limiting resistance of 18k ohms (using V=IR and neglecting the 23 ohm input impedance because it is so small). This will be divided into two resistors, a 10k-1M potentiometer for volume control, and a generic 8k resistor. Thus, our final circuit is the following (Figure 2.11):

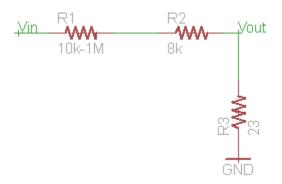


Figure 2.11 – Divider Schematic

Audio Jack

Input	Output
Analog audio	Sounds from headphones

The audio jack we are planning to use is a standard 3.5mm jack, compatible with portable headphones.

USB connection

Input	Output	
USB data from microcontroller	USB signal to computer	

A basic type A USB connection

SD card

Input	Output
- Serial commands from	- Saved audio data on SD card
microcontroller	 Playback of audio data saved on
- Digital Audio Data	SD card

An SD card is needed to save data. Saved data will be in an uncompressed raw file format. The way to access an SD using SPI/SSI interfaces is well documented, see references for more details.

Push Buttons

Input	Output	
Push from hand	Logic high level to be transmitted	
	to microcontroller.	

Push buttons are needed to interact with the user. We are planning on using seven in total, they will have the following functions:

- Start
- Stop
- Pause

- Switch mode (from playback to live recording)
- Record
- Scroll Up
- Scroll Down

These buttons will be wired to the microcontroller using a basic pull up circuit (Figure 2.12):

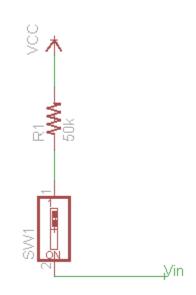


Figure 2.12 – pull up circuit

LCD Display

Input	Output
Display data from microcontroller	Light from display

We are going to use the EA DOGS102W-6. It is a basic black and white LCD display with a resolution of 102x64. Data to be sent into the LCD display is to be sent serially, one byte at a time for each pixel in the array. The LCD display has the following pin-out (Figure 2.13):

PINOUT

The EADOGS102, a 102x64-pixel graphics display, is a new addition to ELECTRONICASSEMBLY's EA DOG series. It, too, has pins that allow it to be mounted quickly and easily.

Pin	Symbol	Level	Function		Pin	Symbol	Level	Function
1	NC		(A1+: LED backlight)		15	VLCD	-	Power LC Drive
2	NC		(C1-: LED backlight)		16	VB1-	-	Voltage Converter
3					17	VB0-	-	Voltage Converter
4				1	18	VB0+	-	Voltage Converter
5				1	19	VB1+	-	Voltage Converter
6				1	20	VSS	L	Power Supply 0V (GND)
7				1	21	VSS	L	Power Supply 0V (GND)
8				1	22	VDD2/3	Н	Power Supply +2,53,3V
9				1	23	VDD1	Н	Power Supply +2,53,3V
10				1	24	SDA	H/L	Data in (SPI: MOSI)
11				1	25	SCK	H/L	Clock (SPI: CLK)
12				1	26	CD	H/L	L= Command, H= Data
13	NC		(C2-: LED backlight)	1	27	RST	L	Reset (active low)
14	NC		(A2+: LED backlight)		28	CS0	L	Chip Select (active low)

Figure 2.13 – Pin-out for LCD display

Power Supply

Input	Output
4.5 V from batteries	3.3 V and 1.2 V voltage levels

Our power supply uses 3 AA batteries and uses two buck converters to provide 3.3V and 1.2 V to the system. These buck converters are LM3671 converters, which can supply a maximum of 600 mA to the rest of the system. Based on the analysis shown in Figure 2.15, our system only comes to about ~53 mA. A schematic is given below (Figure 2.14), which is based on the recommended build in the datasheet:

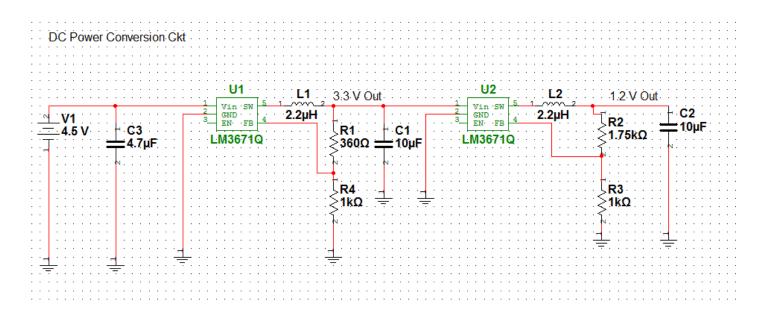


Figure 2.14 – Power Supply schematic

Component	Operating	Operating	Power	Other Notes
	voltage (V)	Current (A)	Consumption	
			(W)	
Mic	3.3	1.60E-04	5.28E-04	
MCU	3.3	4.78E-02	1.58E-01	Worst case scenario with Idd=45.1 mA,
				IddA = 2.71 mA, less current when in Idle
				state
DAC	3.3	1.80E-04	5.94E-04	
LCD	3.3	2.50E-04	8.25E-04	
SD card	3.3	1.00E-05	3.30E-05	
Op-Amp	3.3	3.90E-03	1.29E-02	
		5.23E-02	1.73E-01	
	TOTAL:	52.3 mA	173 mW total	
		total		

Figure 2.15 – Powe	^r consumption	spreadsheet
		00.000.000

3.0 Requirements and Verification

Block From Diagram	Requirement	Verification
Ultrasonic Microphone	 Needs to detect ultrasonic sounds up to 100 KHz. Needs to provide an AC voltage limited in the range of 0 to 1 V, +/- 0.1 V. 	 Using an oscilloscope and an ultrasonic sound generator, test the microphone and measure the exact frequency response by using a sweep of sine frequencies. Using amplitude function of oscilloscope, measure amplitude and ensure requirement is met. When testing for frequency response, sound wave should be normalized at 94 dB SPL. To do this, use a sound level meter to measure dB SPL.
Band pass filter	 Needs to damp "audible" frequency with at least a 9dBm loss while passing the 30 kHz to 100 kHz band with no less than a 10dBm loss. 	 Use a function generator and step through values of sin waves to get the frequency response. Test from 10 kHz-110 kHz with step sizes of 5 kHz.
Input Amplifier	 Needs a gain of 3.3, +/- 5% 	 Use input of 0.5 V (+/- 5%), from a function generator (sine wave). Using oscilloscope, measure amplitude of output. Expected value of output amplitude will be 1.65 V.
Analog to Digital	Needs to sample data	Configure microcontroller to send

Converter	at 1 MSPS • Needs to cover entire range of voltage values, from 0-3.3 V.	 12 bit data to outputs directly. Use function generator to send sine waves ranging from 20 kHz to 100 kHz with step sizes of 10 kHz. Normalize amplitude to 1 V. Using logic analyzer, display output and verify that it is correct Then, using 20-100 kHz sine wave (tester's choice), start from 0.1 V amplitude and step in sizes of 0.1 V until 3.3 V is reached. Ensure quantization is occurring correctly.
Microcontroller	 Microcontroller needs to perform a variety of functions: Interfacing with SD card and LCD display Obtaining data from push buttons Obtaining bat calls from ADC, performing signal processing, and sending data to DAC. Processing input data and providing UI 	 The above testing procedure for the ADC will ensure that the microcontroller interfaces with the ADC correctly. LCD and SD card interface with SPI. An SPI test which will use the necessary pins will verify correct operation. LCD test will be a basic 'Hello World' display. SD Card test will do three things: create two 'Hello World' text files, then delete one, and finally create a directory and move the remaining test file into the directory. Each step can be checked with the help of a computer and SD card reader. DAC test will involve an implementation of the time expansion

		 algorithm. Using a similar method to the ADC test, step through sine waves with frequencies of 20 kHz to 100 kHz. With an oscilloscope, measure the resulting output from the DAC. Test amplitude conditions as given in the DAC section below. UI will have to be tested in incremental pieces. Real-time audio and playback parts will be tested separately.
USB connection to Microcontroller	DSP needs to receive program from USB connection.	Use TI IDE and attempt to connect, run TI example programs.
Microcontroller connection to SD card	Microcontroller needs to interface with SD card	See SD card test in microcontroller section
Push buttons	Switches need to provide high level when touched and open when not touched.	Wire pull up circuit with switches as shown in the push button block diagram section.
LCD display	Needs to display relevant data to the user	See LCD display test above
Digital to Analog Converter	 Needs to correctly reconstruct digital data Needs to provide 3.3V as a maximum at output. 	See DAC test in microcontroller section above.
Output Divider	 Needs to only allow 0.19 mA (0.18 mA plus 0.01 headroom) maximum. Potentiometer needs to be within 10k ohms 	 Wire device together and test with 3.3 V voltage source from function generator. Using multimeter, measure current and

	to 1M ohm, +/- (values from data sheet)	 ensure current is within established limits. Potentiometer can be checked with multimeter to ensure resistance matches manufacturer's information.
Audio Jack	 Audio jack needs to transfer power to headphones 	 Ensuring that current does not exceed 0.19 mA, use function generator to send sine waves within the human hearing range to the audio jack. Plug in headphones and listen.
Power Supply	 Needs to deliver two power lines, +3.3 V and +1.2 V, with at least 53 mA of current (total). 	 Wire up circuit and use 60 ohm and 20 ohm resistors to test each voltage line. Measure current with multimeter and ensure the requirements are met.

4.0 Tolerance Analysis

The first band-pass filter is critical to the operation of the device and will need to have a range of freedom in case there are imperfection in the design or application of the inductor and capacitor. We desire a large loss in the upper range of human hearing (20 kHz); we wanted more than a normal loss and choose 9dBm to be the loss between the peak and the 20 kHz mark. A secondary constraint was to capture the entire "band" from 30 kHz to the 100 kHz. The higher frequencies levels off at a 9dBm loss; we used that number as a rough base for our lower frequencies. So the two constrains on our band-pass filter are 1) a 9dBm loss between peak and 20 kHz and 2) no more than 10dBm loss in the range of 30 kHz to 100 kHz. Using the design in ADS, we used the values +/-10%, working off the assumption that one of the parts will be correct, and found values for the other part to find our constrains. These are the values which we could use by following the constraints laid out previously.

Inductor Value	Capacitor Value	Peak Freq	Peak Gain	20 kHz Gain	30kHz Gain
825 uH	28 nF	35.54 kHz	-5.193 dBm	-14.154 dBm	-6.039 dBm
825 uH	18 nF	45.80 kHz	-5.680 dBm	-19.018 dBm	-10.236 dBm
675 uH	34 nF	30.24 kHz	-5.052 dBm	-14.170 dBm	-5.916 dBm
675 uH	20 nF	46.87 kHz	-5.307 dBm	-19.918 dBm	-10.975 dBm
1125 uH	20 nF	37.22 kHz	-6.003 dBm	-14.789 dBm	-7.127 dBm
675 uH	20 nF	46.87 kHz	-5.307 dBm	-19.918 dBm	-10.975 dBm
900 uH	25 nF	36.37 kHz	-5.373 dBm	-14.516 dBm	-6.396 dBm
575 uH	25 nF	45.80 kHz	-5.060 dBm	-19.683 dBm	-10.615 dBm

5.0 Cost Analysis and Schedule

5.1 Labor Cost Analysis

Team Member	Hourly Rate	Number of hours	Total Cost x 2.5
Paul Logsdon	\$50	200	\$25,000
lan Bonthron	\$50	200	\$25,000

Total Labor Cost: \$50,000

5.2 Parts Cost Analysis

Part	Quantity	Cost
Knowles SPQ0410HR5H-B (Ultrasonic Microphone)	1	\$1.80
360Ω resistor	1	\$0.10
1kΩ resistor	4	\$0.40
1.75kΩ resistor	1	\$0.10
2.3kΩ resistor	1	\$0.10
3.3kΩ resistor	1	\$0.10
8kΩ resistor	1	\$0.10
50kΩ resistor	7	\$0.70
22nF capacitor	1	\$0.32

4.7uF capacitor	1	\$0.32
	1	- J0.J2
10uF capacitor	2	\$1.26
2.2uH inductor	2	\$0.40
750uH inductor	1	\$3.60
PTA4553-2015CPB103 (Slide potentiometer)	1	\$1.18
LM3671 (buck converter)	2	\$1.94
TI OPA830IDBVT (Op-amp)	1	\$1.46
Tiva TM4C123GH6PM (Microcontroller)	1	\$11.36
MAX5216BGUA+ (DAC)	1	\$3.74
EA DOGS102W-6 (LCD display)	1	\$12.36
SJ1-3544 (Audio Jack)	1	\$1.70
USB-A1HSW6 (USB connection)	1	\$0.45
Custom PCB cost	1	\$20.00
Custom casing cost	1	\$20.00
Switches	7 at \$0.62/switch	\$4.34
SD card connector	1	\$2.19

Total Parts Cost: \$90.02

Total Cost (Labor and Parts): \$50,090.02

5.3 Schedule

Week	Paul's Responsibility	lan's Responsibility	
2/10	Finish Proposal, order microphones	Finish proposal	
2/17	Design back end voltage divider	Design band pass filter in ADS	
2/24	Design front end amplifier in ADS	Breadboard and test front end amplifier and band pass filter.	
3/3	Breadboard and test amplifiers/divider (all).	Eagle PCB breakout board design for microphones	
3/10	MCU Programming - shift and frequency compression	Microphone characterization	
3/17	MCU Programming - User Interface/SD card	Breadboard and test band pass filter	
3/24	Eagle PCB layout, microcontroller components	Eagle PCB layout, analog filter/amplifier components	
3/31	DSP integration	Analog Integration	
4/7	Full system test in lab	Model casting	
4/14	Field Testing and being writing microcontroller presentation	Field Testing and being writing presentation	
4/21	Finish microcontroller part of presentation	Finish Analog Filter/Amplifier part of presentation	
4/28	Demo	Demo	

6.0 Ethics Statement and Safety Statement

6.1 Ethics

We do not anticipate any serious ethical issues as we implement our project. However, parts 3 and 7 of the IEEE code of ethics are still relevant to us:

"3. To be honest and realistic in stating claims or estimates based on available data;"

When documenting our data in our lab notebooks and in any written work done for the course, we will provide honest and realistic data to the best of our abilities.

"7. To seek, accept, and offer honest criticism of technical work, to acknowledge and correct errors, and to credit properly the contributions of others;"

Since this project is a sponsored project, we will acknowledge whatever contributions our mentors make to the project. We will also cite any materials used from datasheets or other technical documents.

6.2 Safety Statement

We do not anticipate any serious safety issues as we implement build and test our device. However, there are two minor issues which are of some concern. The first is ensuring that we are using the soldering equipment correctly. We do not want to burn ourselves with the gun or get solder on ourselves. Thankfully, we have received soldering training which makes us qualified to perform this task. We will also need to field test the device, which requires going near areas with bats. Clearly, there is the potential to get hurt when dealing with wild animals. We will be sure to do this field testing with the aid of a qualified professional.

For the end user, the main safety issue is ensuring the audio level is not too loud. An audio level which is too loud can cause hearing loss, which is clearly something to be avoided. Thus, we must put a volume control and volume limiter in place and empirically verify that these things are working correctly. According to the CDC, any sound at or above 85 dB SPL is dangerous. Thus, we will ensure that no sounds are louder than this value.

7.0 References

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